TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HC373AP, TC74HC373AF

Octal D-Type Latch with 3-State Output

The TC74HC373A is a high speed CMOS OCTAL LATCH with 3-STATE OUTPUT fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

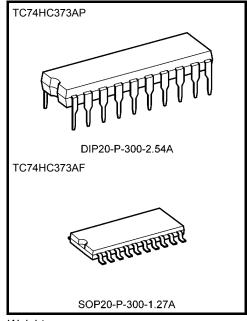
These 8-bit D-type latches are controlled by a latch enable input (LE) and an output enable input (\overline{OE}).

When the $\overline{\rm OE}$ input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

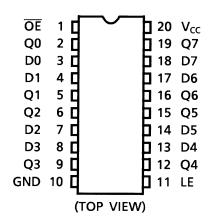
- High speed: $t_{pd} = 11 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance: $|I_{OH}| = I_{OL} = 6 \text{ mA (min)}$
- Balanced propagation delays: $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: V_{CC} (opr) = 2 to 6 V
- Pin and function compatible with 74LS373



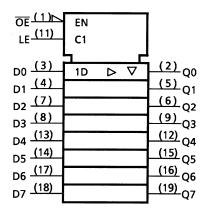
Weight

DIP20-P-300-2.54A : 1.30 g (typ.) SOP20-P-300-1.27A : 0.22 g (typ.)

Pin Assignment



IEC Logic Symbol



Truth Table

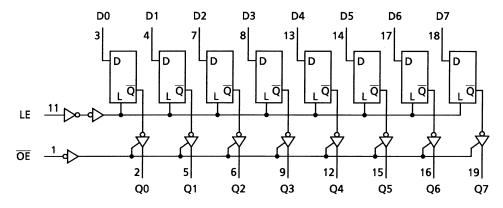
	Output			
ŌĒ	LE	D	Q	
Н	Х	Х	Z	
L	L	Х	Qn	
L	Н	L	L	
L	Н	Н	Н	

X: Don't care

Z: High impedance

 Q_n : Q outputs are latched at the time when the LE input is taken to a low logic level.

System Diagram





Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CC}	–0.5 to 7	V
DC input voltage	V _{IN}	-0.5 to V _{CC} + 0.5	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±35	mA
DC V _{CC} /ground current	Icc	±75	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2 to 6	V
Input voltage	V _{IN}	0 to V _{CC}	V
Output voltage	V _{OUT}	0 to V _{CC}	٧
Operating temperature	T _{opr}	-40 to 85	°C
		0 to 1000 (V _{CC} = 2.0 V)	
Input rise and fall time	t _r , t _f	0 to 500 (V _{CC} = 4.5 V)	ns
		0 to 400 (V _{CC} = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

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Electrical Characteristics

DC Characteristics

Characteristics	Characteristics Symbol		Test Condition $V_{CC} (V)$		Ta = 25°C			Ta = -40 to 85°C		Unit
					Min	Тур.	Max	Min	Max	
		_		2.0	1.50	_	_	1.50	_	
High-level input voltage	V _{IH}			4.5	3.15	_	_	3.15	_	V
ŭ				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V _{IL}		_	4.5	_	_	1.35	_	1.35	V
Ğ				6.0	_	—	1.80	_	1.80	
				2.0	1.9	2.0	_	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage	V _{OH}	VIN = VIH or VIL		6.0	5.9	6.0	_	5.9	_	V
			I _{OH} = -6 mA	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
	V _{OL}	VIN = V _{IH} or V _{IL}		2.0	_	0.0	0.1	_	0.1	
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage				6.0	_	0.0	0.1	_	0.1	V
			I _{OL} = 6 mA	4.5	_	0.17	0.26	_	0.33	
			I _{OL} = 7.8 mA	6.0	_	0.18	0.26	_	0.33	
3-state output	1	$V_{IN} = V_{IH}$ or	V _{IL}	6.0			10.5		15.0	^
off-state current		V _{OUT} = V _{CC} or GND		6.0	_	_	±0.5	_	±5.0	μΑ
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		6.0		_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	V _{IN} = V _{CC} or GND		6.0	_	_	4.0	_	40.0	μА

Timing Requirements (input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	_	Ta = 25°C		Ta = -40 to 85°C	Unit	
			V _{CC} (V)	Тур.	Limit	Limit		
Minimum pulse width			2.0	_	75	95		
(LE)	t _{W (H)}	_	4.5	_	15	19	ns	
			6.0	_	13	16		
Minimum set-up time			2.0	_	50	65		
·	ts	_	4.5	_	10	13	ns	
(Dn)			6.0	_	9	11		
Minimum hold time (Dn)			2.0	_	5	5		
	t _h	_	4.5	_	5	5	ns	
			6.0	_	5	5		



AC Characteristics (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		-	Γa = 25°(Ta = -40 to 85°C		Unit	
	- J		CL (pF)	V _{CC} (V)	Min	Тур.	Max	Min	Max	
Output transition time	t _{TLH} t _{THL}	_	50	2.0 4.5 6.0		20 6 5	60 12 10	_ _ _	75 15 13	ns
Propagation delay time (LE-Q)	^t pLH ^t pHL	_	150	2.0 4.5 6.0 2.0 4.5 6.0		42 14 12 57 19 16	125 25 21 175 35 30		155 31 26 220 44 37	ns
Propagation delay time (D-Q)	^t pLH ^t pHL	_	50 150	2.0 4.5 6.0 2.0 4.5 6.0		42 14 12 57 19 16	125 25 21 175 35 30		155 31 26 220 44 37	ns
Output enable time	t _{pZL} t _{pZH}	R _L = 1 kΩ	50 150	2.0 4.5 6.0 2.0 4.5	 - - -	39 13 11 54 18	125 25 21 175 35	_ _ _ _	155 31 26 220 44	ns
Output disable time	t _{pLZ} t _{pHZ}	$R_L = 1 \text{ k}\Omega$	50	6.0 2.0 4.5 6.0		15 30 14 13	30 125 25 21		37 155 31 26	ns
Input capacitance	C _{IN}	_			5	10	_	10	pF	
Output capacitance	C _{OUT}	_	_		_	10	_	_	_	pF
Power dissipation capacitance	C _{PD} (Note)	_	_		_	38	—	_	—	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC} (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 (per \ latch)$$

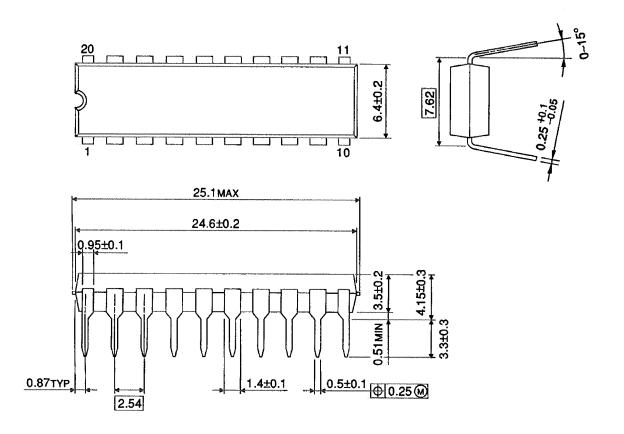
And the total C_{PD} when n pcs. of latch operate can be gained by the following equation:

$$C_{PD}$$
 (total) = 22 + 16 · n

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Package Dimensions

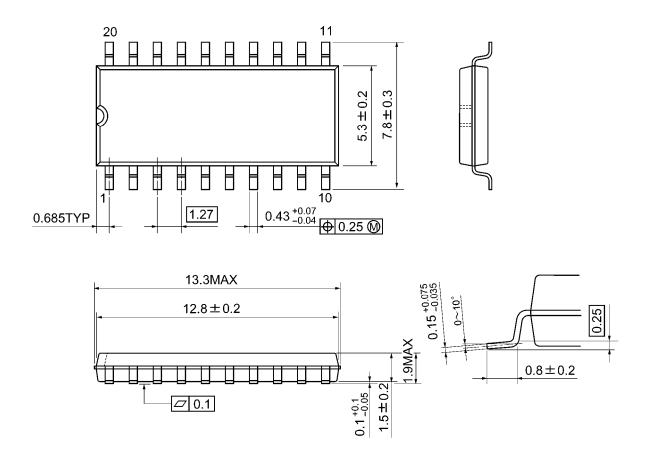
DIP20-P-300-2.54A Unit: mm



Weight: 1.30 g (typ.)

Package Dimensions

SOP20-P-300-1.27A Unit: mm



Weight: 0.22 g (typ.)

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